In the Sp cification

At page 1 before the "Technical Field" section, please insert the following:

--RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent Application Serial No. 10/340,126, filed January 10, 2003, entitled "Methods of Forming Silicon-on-Insulator Comprising Integrated Circuitry, and Wafer Bonding Methods of Forming Silicon-on-Insulator Comprising Integrated Circuitry", naming Zhongze Wang as inventor, the disclosure of which is incorporated by reference; which patent resulted from a divisional application of U.S. Patent Application Serial No. 10/051,981, filed January 16, 2002, entitled "Silicon-on-Insulator Comprising Integrated Circuitry", naming Zhongze Wang as inventor, the disclosure of which is incorporated by reference.--

Amendments to the Specification

Please replace the last paragraph, beginning on page 8 of the specification, as follows:

The most preferred embodiment ultimately includes forming the integrated circuitry to comprise a silicon-on-insulator field effect transistor, for example and by way of example only, that depicted by Fig. 6. Fig. 6 depicts joined substrate 30 having been polished or otherwise etched back to form the depicted silicon comprising material 12 from what was the independent device wafer 10. Further thinning of joined accomplished by polishing or substrate 30 can be chemical/etching means, if desired. An exemplary thickness form for material 12 in Fig. 6 is from about 1000 Angstroms to about 2000 Angstroms. A pair of source/drain regions 32 and 34 have has been formed within silicon comprising layer 12. A gate construction 36 overlies silicon comprising layer 12 intermediate source/drain regions 32 and 34. Such is diagrammatically shown to include a gate dielectric layer 38, insulative sidewall spacers 40, and a conductive transistor gate region 41. Exemplary materials for layers 38 and 40 include silicon dioxide and silicon nitride, with exemplary materials for gate region 41 including conductively doped polysilicon and silicides.